

Docket No.: 085027-0055

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of	:	Customer Number: 89518
	:	
Mou-Shiung Lin, et al.	:	Confirmation Number: 5504
	:	
Application No.: 10/054,001	:	Group Art Unit: 2827
	:	
Patent No.: 6,673,698	:	Issued: January 6, 2004
	:	
For: THIN FILM SEMICONDUCTOR PACKAGE UTILIZING A GLASS SUBSTRATE WITH COMPOSITE POLYMER/METAL INTERCONNECT LAYERS		

**TRANSMITTAL OF POWER OF ATTORNEY**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF ELECTRONIC TRANSMISSION**

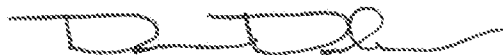
I hereby certify that this correspondence is being electronically-transmitted to the  
United States Patent and Trademark Office on March 28, 2011.  
Patricia A. Balero  
Patricia A. Balero

Sir:

Transmitted herewith is a Fee Address Indication Form, Power Of Attorney to Prosecute Applications Before the USPTO, together with a Statement Under 37 CFR 3.73(b), which revokes all previous powers of attorney given in the above-identified application and associates the application with Customer Number 89518.

Respectfully submitted,

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**Date: March 22, 2011**

**Please recognize our Customer No. 89518  
as our correspondence address.**